An Introduction to the SPEC High Performance Group and their HPC Benchmark Suites

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Chair, High Performance Group (HPG) Standard Performance Evaluation Corporation (SPEC)

> Director, Research Software and Solutions Indiana University

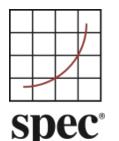
> > January 2019



Content

- SPEC and SPEC HPG
- SPEC Benchmark Philosophy
- SPEC HPG Benchmarks
- Benchmark Use Cases
- How to Contribute





SPEC is a non-profit corporation formed in 1988 to establish, maintain and endorse standardized benchmarks and tools to evaluate performance and energy efficiency for the newest generation of computing systems.

- OSG: Open System Group
- HPG: High Performance Group
- GWPG: Graphics & Workstation
 Performance Group
- RG: Research Group

Largest & Oldest Group

- Cloud
- CPU
- Java
- Power
- Virtual Machine
- File Server





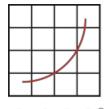
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HPC benchmarks

- MPI
- OpenMP
- Accelerator
 - OpenCL
 - OpenACC
 - OpenMP 4.5





Cloud

Storage

Virtualization

Results Search

Submitting Results

SFS/Virtualization ACCEL/MPI/OMP

Chauffeur WDK

Order Form

Downloads

About SPEC

Member organizatio

GWPG

HPG OSG

RG Membership

SPEC

Cloud/CPU/Java/Power

SPECapc/SPECviewperf/SPECwood

Power

Tools

SERT PTDaemor

Graphics/Workstations

Java Client/Server
 Mail Servers

136 Organizations, including:

- 99 companies
 - 37 academic institutions

Home Benchmarks * Tools * Results * Contact Site Map Search Help

The SPEC Consortium: Members and Associates

SPEC Members:

Acer Inc. * Action S.A. * Advanced Micro Devices * Amazon Web Services, Inc. * Apple Inc. * ARM * Avere Systems * Bull SAS * Cavium Inc. * Ciara Technologies Inc. * Cisco Systems, Inc. * Dell, Inc. * Digital Ocean * E4 Computer Engineering SPA * Fujitau * Gartner, Inc. * Giuzhou Huaxintong Semiconductor Technology Co. Ltd * Hitachi Data Systems * Hitachi Ltd. * Hewlett Packard Enterprise * HP Inc. * Huawei Technologies Co. Ltd. * IBM * Inspur Corporation * Intel * Lenovo * M Computers s.r.o. * Microsoft * NEC - Japan * NetApp * New H3C Technologies Co., Ltd. * NVIDIA * Oracle * OVH SAS * Primary Data * Principled Technologies * Pure Storage * Qualcomm Technologies Inc. * Quanta Computer, Inc. * Red Hat * Samsung * SAP AG * Seagate * Sugon * Super Micro Computer, Inc. * SUSE * Taobao (China) Software Co. Ltd. * Unisys * Veritas Technologies * Via Technologies * Wexare * WekaIO *

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SPEC Research Group:

Advanced Strategic Technology LLC * Apple Inc. * ARM * bankmark UG * Barcelona Supercomputing Center * BEZNet * Charles University * Cisco Systems * Cloudera, Inc * Compilaflows * Delft University of Technology * Delf * Escuela Superior Politecnica del Litoral * fortiss GmbH * Friedrich-Alexander-University Erlangen-Nuremberg * Goethe University Frankfurt, Big Data Lab * Hewlett Packard Enterprise * Huawei * IBM * Imperial College London * Institute for Information Industry, Taiwan * Intel * Karlsruhe Institute of Technology * Kiel University * Linkoping University * Lund University * Microsoft * NICTA * NovaTec Consulting GmbH * Oracle * Purdue University * Queen's University * Red Hat * RETIT GmbH * RWTH Aachen University * SalesForce.com * San Diego Supercomputing Center * San Francisco State University * SAP AG * Stiftung University * SINTEF * Software Performance and Scalability Consulting * Tata Consultancy Services * Technica Corporation * Technische University of North Florida * University of Paderborn * University of Stuttgart * University of Texas at Austin * University of Wuerzburg * University Politehnica of Bucharest* VMware * York University*

To learn about SPEC Membership, please read the SPEC FAQ.

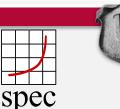


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HPG develops benchmarks to represent high-performance computing applications for standardized, cross-platform performance evaluation.



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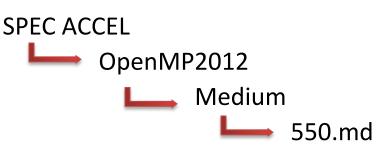


- The result of a SPEC benchmark is one SPEC score.
 - Higher is better
 - Some benchmarks support power measurement
- This score is in relation to a reference machine.
 - Each benchmark has its own reference machine
- SPEC (HPG) benchmarks are "full" applications.
 Including all the overhead of a real application
- SPEC harness ensures correctness of results.
 - To detect "overly aggressive optimization" and tampering
- Each benchmark suite has run rules and documentation requirements.



Hierarchy within benchmark suits

- Benchmark suite ۲
- Benchmark
- Dataset size
- Component



Benchmarks support "Base" and "Peak" configuration

These yield separate SPEC scores, "Peak" runs allow for more freedom.

Base runs

- The same optimization compiler switches for all components
- The same level of parallelism ۲
- Only portability switches allowed

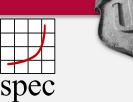


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Result submission:

- Obtain and install the benchmark
- Perform a valid run and describe hardware and software configuration
- Submit result for review (and publication) to SPEC HPG 2 week review process
- If needed, define embargo period
- Results are published on SPEC website
- A curated result repository:
 - Given appropriate hardware and software.... a published result should be reproducible with the information available in the submission.
 - Peer reviewed results are so much better than "everyone can upload a result"!
 - The value of a benchmark suite lies in public results, their correctness and the ability to compare them.



OpenACC (31):

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Indiana University	Cray XK7	HTML CSV Text PDF PS Config	NVIDIA Tesla K20	1.77	Not Run		
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CPU(s) orderable 1 to 1 chip Primary Cache: 32 KB 1+ 32 KE Secondary Cache: 1 MB 1+D on chi L3 Cache: None Other Cache: None Other Cache: None Disk Subsystem: Intel S3510 SSD Other Har dware: None Chier Har dware: None	FPU: I	Integrated		
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Secondary Cache: 1 MB 1+D on ch Fortran benchmarks: L3 Cache: None Other Cache: None Other Cache: None Memory: 96 GB (6x 16 G +16 GB MCDR Disk Subsystem: Intel \$3510 SD Other Hardware: None			-O3 -qopenmp -qopenmp-offload=host -xMIC-AVX512	
L3 Cache: None Other Cache: None Other Cache: None Memory: 96 GB (6 x 16 G +16 GB MCDR Disk Subsystem: Intel \$3510 \$SD Other Hardware: None			Fortran benchmarks:	
L3C ache: None Other Cache: None Memory: 96 GB (6 x 16 G + 16 G MCDR. Disk Subsystem: Intel S3510 SSD Other Hardware: None				
Memory: 96 GB (6 x 16 G + 16 GB MCDR Disk Subsystem: Intel \$3510 SSD Other Hardware: None				
+ 16 GB MCDR Disk Subsystem: Intel S3510 SSD Other Hardware: None The flags files that were used to format this result can be browsed at https://www.spec.org/accel/flags/intel-ic17.0-linux64.html, https://www.spec.org/accel/flags/colfax-knl.html. You can also download the XML flags sources by saving the following links: https://www.spec.org/accel/flags/intel-ic17.0-linux64.ntml.	Memory: 9	96 GB (6 x 16 G		
Other Hardware: None The flags files that were used to format this result can be browsed at https://www.spgc.org/accel/flags/intel-ic17.0-linux64.html, https://www.spgc.org/accel/flags/outfacs/intel-ic17.0-linux64.html, html; https://www.spgc.org/accel/flags/outfacs/intel-ic17.0-linux64.html, html; h	+			
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http://www.spec.org/accel/flags/furle-iic17.Pii/uux64.xml.			You can also download the XML flags sources by saving the following links:	
r ower Subdiv:	Power Supply:		https://www.spec.org/accel/flags/lotlei-ic17.0-linux64.xml. https://www.spec.org/accel/flags/colfac-kml.xml.	

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- SPEC and SPEC HPG
- SPEC Benchmark Philosophy
- SPEC HPG Benchmarks
- Benchmark Use Cases
- How to Contribute



SPEC HPG Benchmarks - Pricing

- Different groups in SPEC have different policies on the sale of benchmarks.
- Since March 2018, SPEC HPG benchmarks are available free of charge to non-profit organizations, including universities and research labs.
- SPEC HPG hopes that this will encourage even more organizations to actively participate.



SPEC HPG Benchmarks - ACCEL

- SPEC Accel provides a comparative performance measure of
 - Hardware accelerator devices (GPU, Co-processors, etc.)
 - Supporting software tool chains (Compilers, Drivers, etc.)
 - Host systems and accelerator interface (CPU, PCIe, etc.)
- Computationally-intensive parallel HPC applications and miniapps
- Portable across multiple accelerators
- Three distinct benchmarks, initially released in 2014, updated in 2017:
 - OpenCL v1.1
 19 C/C++ applications
 - OpenACCv 1.0 15 Fortran/C applications
 - OpenMP v4.5, 15 Fortran/C applications
- Support for power measurement

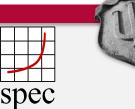


RESEARCH TECHNOLOGIES

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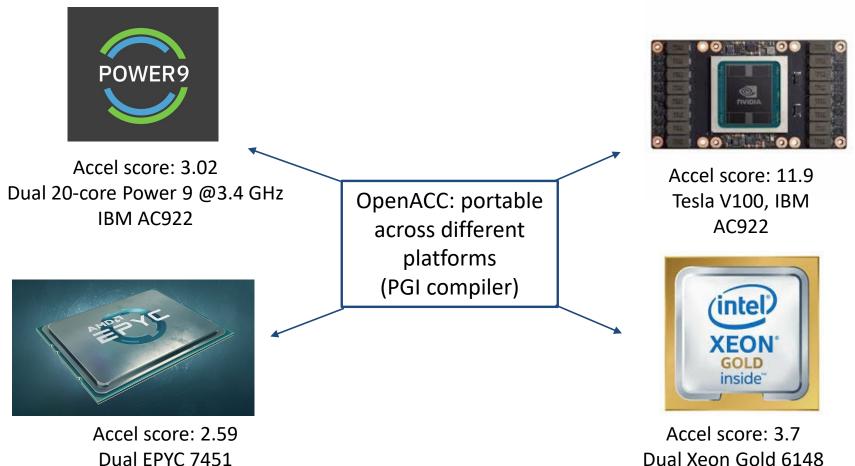
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SPEC HPG Benchmarks - ACCEL





SPEC HPG Benchmarks – OMP2012

- Follow on to SPEC OMP2001
- 14 applications Fortran/C
- Scales up to 512 threads
- Support for power measurement

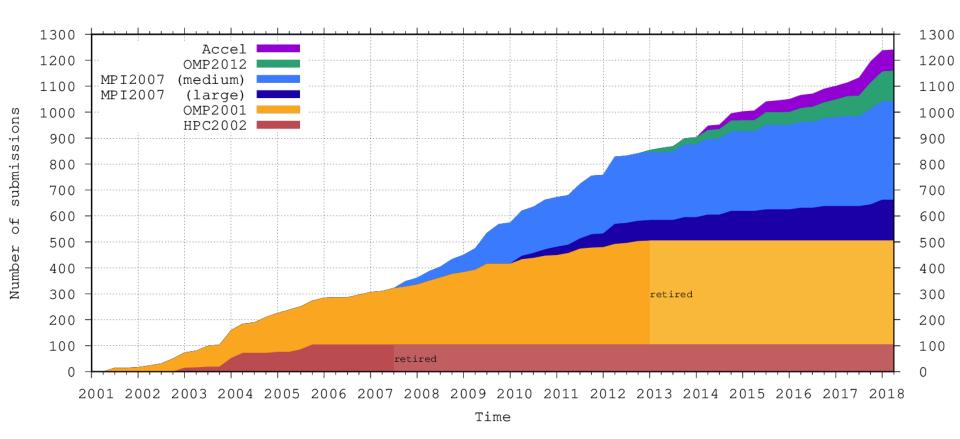


SPEC HPG Benchmarks – MPI2007

- Large and medium data set
- 13 applications in Fortran/C/C++
- Scales to 2048 MPI processes
- Power not supported



Published Results





Future SPEC HPG Benchmarks – MPI+X

- First hybrid benchmark, posing lots of challenges for run rules and metrics
 - "+X" can be anything, including, OpenMP, OpenACC, CUDA, TBB, Kokkos, PTHREADS, ...
- Search program in 2017 and 2018, benchmark creation in 2018 and 2019
- More than a dozen candidates submitted from 3 continents and 6 different countries and more to come.



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Use Cases

- System, accelerator and software vendors
- Application developers
- Users and HPC centers
- Researchers
- Examples



Use Cases – Vendors

- Marketing
- Drive benchmark development
 - To utilize state of the art hardware/software features
- Internal validation suite
 - Compiler
 - OMP / MPI runtime libraries
- Prepare for RFPs



Use Cases – Application Developers

- Include their application in the benchmark suite
 - See results on a lot of different systems.
- Compare hardware and software stack
 - Compilers
 - Parallel runtimes
 - Different versions of processors
 - Different interconnects



Use Cases – HPC Centers

- Include the benchmarks in the RFP process
- Use them for performance regression testing
 - Hardware
 - Software
- System configuration and tuning
- Power consumption

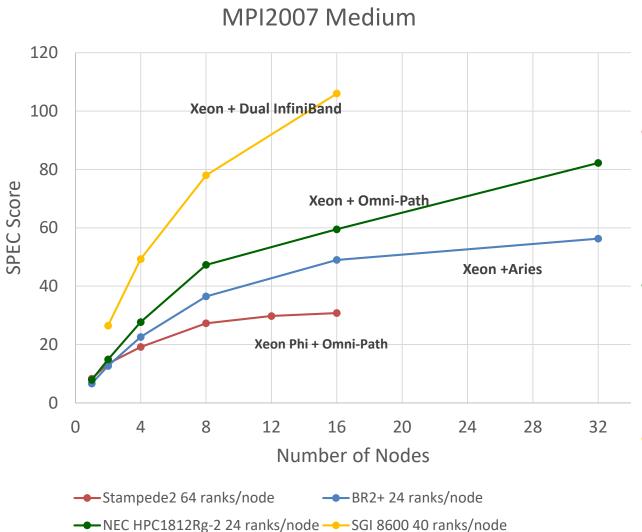


Use Cases – Researchers

- Scalability studies
- Novel implementations of parallel runtime libraries
- Detailed power consumption studies
- Comparison of parallel programming paradigms



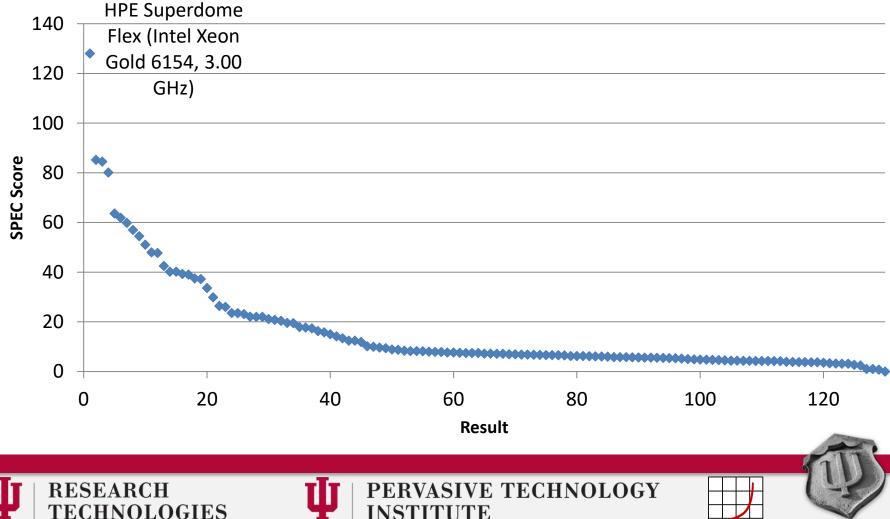
System and Interconnect Comparison



- BR2+ node:
 - 2x Xeon E5-2697 v2 (24C)
 - Cray Aries interconnect
 - Cray MPI
 - Dragonfly
 - Stampede2 node:
 - Xeon Phi 7250 (68C)
 - Intel Omni-Path interconnect
 - Intel MPI
 - Fat tree
 - NEC HPC1812Rg-2 node:
 - 2x Xeon E5-2650 v4 (24C)
 - Intel Omni-Path interconnect
 - Intel MPI
 - Fat tree
- HPE SGI 8600 node:
 - 2x Xeon Gold 6148 (40C)
 - Dual-rail InfiniBand 4X EDR
 - HPE SGI MPI
 - Enhanced hypercube 29

OpenMP Performance Over Time

SPEC OMP2012



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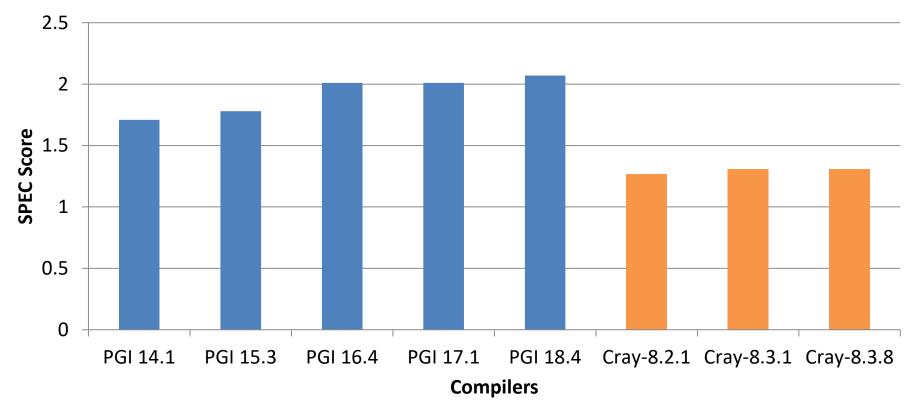
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spec

Compiler Performance Over Time

SPEC ACCEL OpenACC on IU Cray XK7 NVIDIA TESLA K20





OpenACC on CPUs and GPUs

12 10 8 SPEC Score 6 4 2 0 AMD EPYC **NVIDIA Tesla NVIDIA Tesla VVIDIA Tesla NVIDIA GeForce NVIDIA Tesla P100 NVIDIA Tesla V100 NVIDIA Tesla V100 AMD** Radeon AMD FirePro IBM Power 9 NVIDIA Quadro **NVIDIA Tesla** NVIDIA Tesla P100 E5-2697 v2 E5-2698 v3 E5-2698 v4 * Gold 6148 * Intel Xeon Intel Xeon Intel Xeon Intel Xeon 7451 * HD 7970 AC922 * OpenPower * s9150 C2070 *STX TITAN* OpenPower K20 K40 K80 6000 Intel * Intel

Devices used in SPEC ACCEL OpenACC Submissions

* Results from Version 1.2 of the SPEC ACCEL benchmark while all other results are from version 1.1.

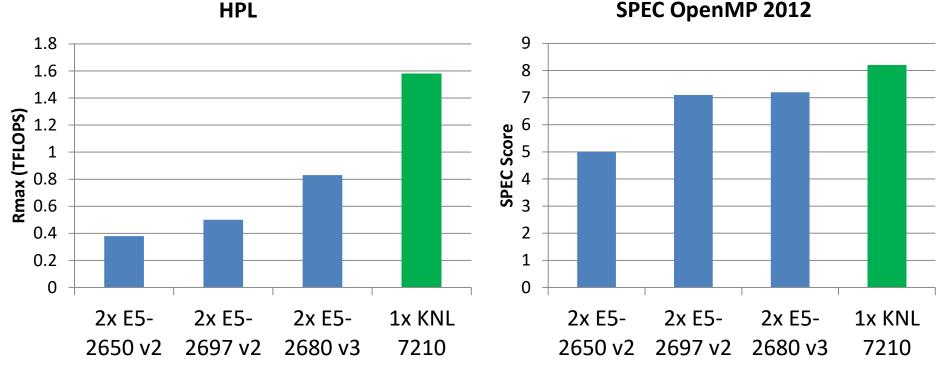
Experimental Results OpenMP Offload

- Cray and IBM compilers support OpenMP 4.5 offload to GPUs. We only had access to the Cray compiler and currently only 6 of 15 benchmarks work!
- RPeak: KNL-7210 2.60 TFlops K20 1.17 TFlops Ratio: 2.2x

	SPEC Sco	re (Estimate)	Speed	up	
Benchmarks	KNL(MCDRAM) intel	KNL(DDR4) intel	K20 cray	KNL(MCDRAM) vs K20	KNL(DDR4) vs K20
503.postencil	1.99	0.70	1.26	1.6x	0.6x
504.polbm	3.42	0.75	0.90	3.8x	0.8x
514.pomriq	2.71	2.72	1.11	2.4x	2.4x
555.pseismic	2.83	1.06	1.43	2.0x	0.7x
560.pilbdc	8.43	1.97	4.61	1.8x	0.4x
570.pbt	27.4	20.2	18.2	1.5x	1.1x
Geometric Avg				2.1x	0.8x

HPL vs. SPEC OpenMP 2012

HPL vs. SPEC OpenMP 2012



SPEC OpenMP 2012



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How to Contribute to SPEC HPG

- Submit results
- Join SPEC HPG
- Result review
- Test new benchmark kits on your hardware
- Help with benchmark development



Benchmark Development Process

- Group effort, with lots of discussions
- Working with experts that are developing the programming model.
- Final decisions are by vote, we strive for consensus
- Technical and infrastructure work
 - Find benchmark components and define run rules
- Using SPEC provided tools
 - GIT, SPEC harness, "common rules"
 - Websites, mailing lists, meeting venues



Conclusion

- SPEC has been around for a long time.
- SPEC benchmarks are created and maintained by a broad mix of industry and academia.
- There is great value in peer reviewed results and a public searchable result repository.
- SPEC HPG is working on the next benchmark, targeting hybrid parallelism.
- Please consider joining and contributing to benchmark development and submitting results.



Thank You!

Questions?

